PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

| SUBMISSION TYPE: | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|----------------------|----------------|
| Ewald K. M. Gunther | 09/03/2013 |
| Andreas Plobl | 08/22/2013 |
| Heribert Zull | 08/23/2013 |
| Thomas Veit | 08/26/2013 |
| Mathias Kampf | 09/02/2013 |
| Jens Dennemarck | 08/22/2013 |
| Bernd Bohm | 09/02/2013 |
| Korbinian Perzimaier | 09/16/2013 |

RECEIVING PARTY DATA

| Name: | OSRAM Opto Semiconductors GmbH |
|-----------------|--------------------------------|
| Street Address: | Leibnizstrasse 4 |
| City: | Regensburg |
| State/Country: | GERMANY |
| Postal Code: | 93055 |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 13984081 |

CORRESPONDENCE DATA

Fax Number: 2156562498

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

215-656-3381 Phone:

Email: pto.phil@dlapiper.com Correspondent Name: T. Daniel Christenbury Address Line 1: One Liberty Place

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REEL: 031239 FRAME: 0060

PATENT

| ATTORNEY DOCKET NUMBER: | EHF-13-1250 |
|--|-------------|
| NAME OF SUBMITTER: | Carol Coney |
| Signature: | /cc/ |
| Date: | 09/19/2013 |
| Total Attachments: 36 source=EHF-13-1250#page1.tif source=EHF-13-1250#page3.tif source=EHF-13-1250#page3.tif source=EHF-13-1250#page4.tif source=EHF-13-1250#page5.tif source=EHF-13-1250#page6.tif source=EHF-13-1250#page7.tif source=EHF-13-1250#page9.tif source=EHF-13-1250#page9.tif source=EHF-13-1250#page10.tif source=EHF-13-1250#page11.tif source=EHF-13-1250#page12.tif source=EHF-13-1250#page13.tif source=EHF-13-1250#page14.tif source=EHF-13-1250#page15.tif source=EHF-13-1250#page16.tif source=EHF-13-1250#page17.tif source=EHF-13-1250#page19.tif source=EHF-13-1250#page20.tif source=EHF-13-1250#page21.tif source=EHF-13-1250#page21.tif source=EHF-13-1250#page22.tif source=EHF-13-1250#page22.tif source=EHF-13-1250#page28.tif source=EHF-13-1250#page28.tif source=EHF-13-1250#page29.tif source=EHF-13-1250#page30.tif source=EHF-13-1250#page30.tif source=EHF-13-1250#page31.tif source=EHF-13-1250#page33.tif source=EHF-13-1250#page33.tif source=EHF-13-1250#page33.tif source=EHF-13-1250#page35.tif source=EHF-13-1250#page35.tif source=EHF-13-1250#page35.tif source=EHF-13-1250#page35.tif source=EHF-13-1250#page35.tif | |

ASSIGNMENT

For good and valuable consideration, I (We),

Ewald Karl Michael Günther, residing at Espental 10 93128 Regenstauf Germany citizen of Germany

Andreas <u>Plößl</u>, residing at Johann-Igl-Weg 24 93051 Regensburg Germany citizen of Germany

Heribert Zull. residing at Charles-Lindbergh-Str. 6 93049 Regensburg Germany citizen of German

Thomas <u>Veit</u>, residing at Im Anger 93 93098 Mintraching Germany citizen of Germany

Mathias <u>Kämpf.</u> residing at Richard-Wagner-Str. 52 93133 Burglengenfeld Germany citizen of Germany

Jens <u>Dennemarck</u>, residing at Hadamarstr. 22D 93051 Regensburg Germany citizen of Germany

Bernd Böhm, residing at Embacher Str. 14 93083 Obertraubling Germany citizen of Germany

Korbinian <u>Perzlmaier</u>, residing at Bischof-Konrad-Str. 2 93051 Regensburg Germany citizen of Germany

Page 2 of 4

hereafter individually or collectively referred to as "Assignor(s)";

Hereby, (I) acknowledge having previously assigned, sold and transferred to OSRAM Opto Semiconductors GmbH, a corporation organized and existing under the laws of GERMANY, having its principal place of business at Leibnizstr. 4 in 93055 Regensburg, hereinafter "Assignee", its successors, assigns and legal representatives, or to a predecessor of Assignee, pursuant to (A)(i) the laws of GERMANY or (ii) a Patent & Secrecy Agreement or similar legal document such as, without limitation, an employee agreement executed at the time of entering into the employment of, or executed as a condition of continuing employment with, the Assignee or a predecessor of the Assignee, the entire right, including any and all priority rights, title and interest, in and for the United States and all foreign countries, in and to any and all inventions or improvements which are disclosed in an invention disclosure and/or in the below-identified documents currently filed with this Assignment, already filed or granted for Letters Patent (in which case, any provision of the subject Assignment that is in conflict with or is in addition to any provision in the prior agreement(s) or assignment(s) then this Assignment shall govern, take precedence, and be of legal effect), or

(B)(i) to the extent such laws of GERMANY or such Patent & Secrecy Agreement or similar legal document failed or fails, in whole or part, to have assigned, sold or transferred the entire right (including priority rights), title and interest, in and for the United States and all foreign countries, in and to all inventions or improvements which are disclosed in the below-identified application(s) or pending application(s) or granted Letters Patent, or (ii) if no such agreement(s) exist assigning, selling or transferring any such right (including priority rights), title or interest; then for good and valuable consideration, Assignor(s) now and hereby, effective Nunc Pro Tunc on the filing date of the below identified patent application(s), pending patent application(s) or granted Letter Patent(s), assign, sell and transfer(s) to Assignee, its successors, assigns and legal representatives, the entire right, (including all priority rights), title and interest in and for the United States and all foreign countries, in and to any and all inventions and/or improvements which are disclosed in the following identified; patent application(s), pending patent application(s) or granted Letter Patent(s)

Patent Application Title: CARRIER SUBSTRATE AND METHOD FOR PRODUCING

SEMICONDUCTOR CHIPS

Filing Date: 08/07/2013 (MM/DD/YYYY)

Filing Number: 13/984,081

Internal Case Number(s): EHF-13-1250

and in and to said application(s) or granted patents and all applications claiming priority to said application or granted patent, including, without limitation, and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of the inventions and/or improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on the inventions and/or improvements;

(II) Agree that said Assignee may apply for and receive Letters Patent for said inventions and/or improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said inventions and/or improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said inventions and/or improvements and the history thereof; and generally do everything possible which said Assignee, its successors,

P2011,0109 US N / 2010P24177WOUS

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assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said inventions and/or improvements and for vesting title to said inventions and or improvements and all applications for patents and all patents on said inventions and/or improvements, in said Assignee, its successors, assigns and legal representatives; and

(III) Covenant with said Assignee, its successors, assigns and legal representatives that

no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned. Enry Kul Hleve Go 03. SeptenSx-2013 HARIANNE RENNER printed name of witness Andreas Plößl Witness Signature Date printed name of witness Heribert Zull Witness Signature Date printed name of witness Thomas Veit Witness Signature Date printed name of witness

| Witness Signature | Mathias Kämpf |
|-------------------------|--|
| printed name of witness | Date |
| Witness Signature | Jens Dennemarck |
| printed name of witness | Date |
| Witness Signature | Bernd Böhm |
| printed name of witness | Date |
| Witness Signature | Korbinian Perzlmaier |
| printed name of witness | Date Companies Representative(s) OSRAM Opto Semiconductors GmbH Signature Name |
| | Signature Name Date |

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Patent Application Title: CARRIER SUBSTRATE AND METHOD FOR PRODUCING

SEMICONDUCTOR CHIPS

Filing Date: 08/07/2013 (MM/DD/YYYY)

Filing Number: 13/984,081

Internal Case Number(s): EHF-13-1250

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(II) Agree that said Assignee may apply for and receive Letters Patent for said inventions and/or improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said inventions and/or improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said inventions and/or improvements and the history thereof; and generally do everything possible which said Assignee, its successors,

P2011,0109 US N / 2010P24177WOUS

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(III) Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

| Witness Signature | Ewald Karl Michael Günther |
|-------------------------|----------------------------|
| printed name of witness | Date |
| Witness Signature | Andreas Plößl |
| printed name of witness | 22nd Aug. 2013 Date |
| Witness Signature | Heribert Zull |
| printed name of witness | Date |
| Witness Signature | Thomas Veit |
| printed name of witness | Date |

| Witness Signature | Mathias Kämpf |
|-------------------------|---|
| printed name of witness | Date |
| Witness Signature | Jens Dennemarck |
| printed name of witness | Date |
| Witness Signature | Bernd Böhm |
| printed name of witness | Date |
| Witness Signature | Korbinian Perzlmaier |
| printed name of witness | Companies Representative(s) OSRAM Opto Semiconductors GmbH Signature Name Date Signature Name |
| | Date |

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For good and valuable consideration, I (We),

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SEMICONDUCTOR CHIPS

Filing Date: 08/07/2013 (MM/DD/YYYY)

Filing Number: 13/984,081

Internal Case Number(s): EHF-13-1250

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same as herein expressed is possessed by the undersigned. Ewald Karl Michael Günther Witness Signature Date printed name of witness Andreas Plößl Witness Signature Date printed name of witness Heribert Zull Witness Signature MICHAEL BLUEDURM printed name of witness Thomas Veit Witness Signature Date printed name of witness

| Witness Signature | Mathias Kämpf |
|-------------------------|--|
| printed name of witness | Date |
| | Jens Dennemarck |
| Witness Signature | Jens Dememarck |
| printed name of witness | Date |
| | |
| Witness Signature | Bernd Böhm |
| printed name of witness | Date |
| Witness Signature | Korbinian Perzlmaier |
| Williess dignature | |
| printed name of witness | Companies Representative(s) |
| | OSRAM Opto Semiconductors GmbH Signature |
| | Name |
| | Date |
| | Signature Name |
| | Date |

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|---|----------------------------|
| Witness Signature | Ewald Karl Michael Günther |
| printed name of witness | Date |
| Witness Signature | Andreas Plößl |
| printed name of witness | Date |
| Witness Signature | Heribert Zull |
| printed name of witness | Date |
| Witness Signature | Thomas Veit |
| Martin Heinz printed name of witness | 26 August 2013 Date |

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Witness Signature

Ewald Karl Michael Günther

| printed name of witness | Date | |
|-------------------------|---------------|--|
| Witness Signature | Andreas Plößl | |
| printed name of witness | Date | |
| Witness Signature | Heribert Zull | |
| printed name of witness | Date | |
| Witness Signature | Thomas Veit | |
| printed name of witness | Date | |

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SEMICONDUCTOR CHIPS

Filing Date: 08/07/2013 (MM/DD/YYYY)

Filing Number: 13/984,081

Internal Case Number(s): EHF-13-1250

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P2011,0109 US N / 2010P24177WOUS

Page 3 of 4

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(III) Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property

herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned. Ewald Karl Michael Günther Witness Signature Date printed name of witness Andreas Plößl Witness Signature Date printed name of witness Heribert Zull Witness Signature Date printed name of witness Thomas Veit Witness Signature Date printed name of witness

| To Andrewith Witness Signature | Docket No.: EHF-13-1250 P2011,0109 US N / 2010P24177WOUS Page 4 of 4 Clothias Licen Mathias Kämpf |
|--|--|
| Thomas Adlhoch printed name of witness | September 102/2013 Date |
| Witness Signature | Jens Dennemarck |
| printed name of witness | Date |
| Witness Signature | Bernd Böhm |
| printed name of witness | Date |
| Witness Signature | Korbinian Perzlmaier |
| printed name of witness | Date Companies Representative(s) OSRAM Opto Semiconductors GmbH Signature Name Date |
| | Signature Name Date |

ASSIGNMENT

Am Brennofen 54

93055 Regensburg

For good and valuable consideration, I (We),

Ewald Karl Michael Günther, residing at Espental 10 93128 Regenstauf Germany citizen of Germany

Andreas Plößl, residing at Johann-Igl-Weg 24 93051 Regensburg Germany citizen of Germany

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citizen of Germany

citizen of Germany

Bernd Böhm, residing at Embacher Str. 14 93083 Obertraubling Germany

Korbinian Perzlmaier, residing at Bischof-Konrad-Str. 2 93051 Regensburg Germany citizen of Germany

Jun Don 2 22. August 2013

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Filing Date: 08/07/2013 (MM/DD/YYYY)

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(III) Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

| Witness Signature | Ewald Karl Michael Günther |
|-------------------------|----------------------------|
| printed name of witness | Date |
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| printed name of witness | Date |
| Witness Signature | Heribert Zull |
| printed name of witness | Date |
| Witness Signature | Thomas Veit |
| printed name of witness | Date |

Page 4 of 4

| Witness Signature | Mathias Kämpf |
|---|--|
| printed name of witness | Date |
| Chris A C | Jens Dennemarck |
| CHRISTO PH MANNAL printed name of witness | Jené Dennemarck 22 August 2013 Date |
| Witness Signature | Bernd Böhm |
| printed name of witness | Date |
| Witness Signature | Korbinian Perzlmaier |
| printed name of witness | Date Companies Representative(s) OSRAM Opto Semiconductors GmbH Signature Name Date Signature Name Date |

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Filing Date: 08/07/2013 (MM/DD/YYYY)

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Date

printed name of witness

Mathias Kämpf Witness Signature Date printed name of witness Jens Dennemarck Witness Signature Date printed name of witness Witness Signature MARTIN HERZ printed name of witness Korbinian Perzlmaier Witness Signature Date printed name of witness Companies Representative(s) OSRAM Opto Semiconductors GmbH Signature Name Date -Signature Name Date

Docket No.: EHF-13-1250

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P2011,0109 US N / 2010P24177WOUS

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Patent Application Title: CARRIER SUBSTRATE AND METHOD FOR PRODUCING

SEMICONDUCTOR CHIPS

Filing Date: 08/07/2013 (MM/DD/YYYY)

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Witness Signature

Ewald Karl Michael Günther

| Witness Signature | |
|-------------------------|---------------|
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| Witness Signature | Andreas Plößl |
| printed name of witness | Date |
| Witness Signature | Heribert Zull |
| printed name of witness | Date |
| Witness Signature | Thomas Veit |
| printed name of witness | Date |

| Witness Signature | Mathias Kämpf |
|--|--|
| printed name of witness | Date |
| Witness Signature | Jens Dennemarck |
| printed name of witness | Date |
| Witness Signature | Bernd Böhm |
| printed name of witness | Date |
| De His Pele Witness Signature | Korbinian Perzlmaier |
| Datthias Poter printed name of witness | Companies Representative(s) OSRAM Opto Semiconductors GmbH Signature |
| | Name Date |
| | Signature Name Date |

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| printed name of witness | Date Companies Representative(s) OSRAM Opto Semiconductors GmbH |
| | Signature Name Aldo Kamper Président & CEO Date Signature |
| | Name Josef Ringsgwandl CFO Date 0 4 SEP 2013 |

PATENT REEL: 031239 FRAME: 0097

RECORDED: 09/19/2013